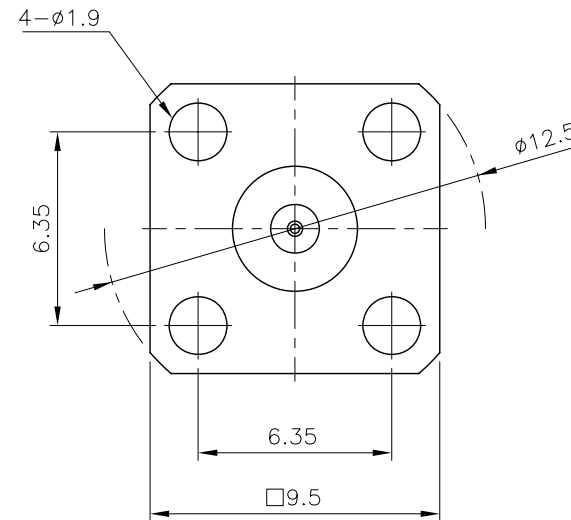
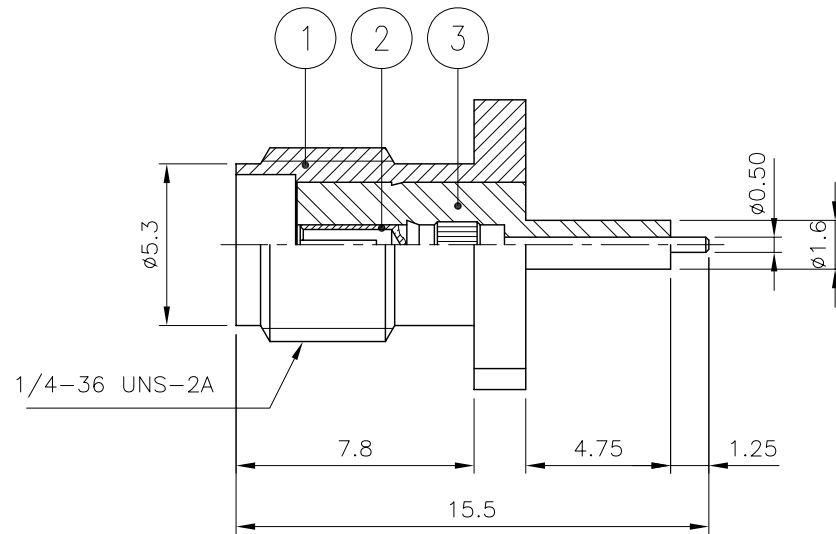


REVISION				
REV	DESCRIPTION	DRAWN	APPR	DATE
IR	Initial Registration	I.C.KIM	Y.H.CHOI	2014. 03. 18.



3	INSULATOR	1	TEFLON		DIN01842-N/1
2	CONTACT	1	Beryllium Copper	Gold 0.03 μ m min.	DCT02355-5/2
1	BODY	1	Stainless Steel	Passivate	DBD02837-5/2
NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

TOLERANCE	Decimal	DATE 2014. 03. 18.		 RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017
	Angle	APPROVED BY	I.C.KIM	
MATERIAL		CHECKED BY	E.M.KIM	KJ COMTECH CO.,LTD. TITLE SMA50 SOLDER END JS-4H
		DRAWN BY	M.H.SONG	
FINISH		SCALE	4/1	A4 DWG NO. CN02605-7/2 REVISION I R SHEET 1 of 1
		UNIT	mm	